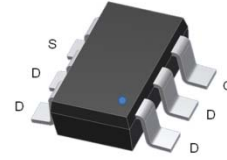


P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	-20V
$R_{DSON (MAX.)}$	60m Ω
I_D	-4.5A



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	± 12	V
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	-4.5	A
	$T_A = 70^\circ\text{C}$		-3.2	
Pulsed Drain Current ¹		I_{DM}	-18	
Power Dissipation	$T_A = 25^\circ\text{C}$	P_D	1.25	W
	$T_A = 70^\circ\text{C}$		0.8	
Operating Junction & Storage Temperature Range		T_{j}, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Ambient	$R_{\theta JA}$		100	$^\circ\text{C}/\text{W}$

¹Pulse width limited by maximum junction temperature.

²Duty cycle $\leq 1\%$



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.3	-0.75	-1.2	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 12V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -16V, V_{GS} = 0V$			-1	μA
		$V_{DS} = -16V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$			-10	
On-State Drain Current ¹	$I_{D(ON)}$	$V_{DS} = -5V, V_{GS} = -4.5V$	-4.5			A
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = -4.5V, I_D = -3.5A$		50	60	m Ω
		$V_{GS} = -2.5V, I_D = -2.5A$		75	96	
		$V_{GS} = -1.8V, I_D = -1.0A$		150	250	
Forward Transconductance ¹	g_{fs}	$V_{DS} = -5V, I_D = -3.5A$		10		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = -10V, f = 1MHz$		382		pF
Output Capacitance	C_{oss}			70		
Reverse Transfer Capacitance	C_{rss}			60		
Total Gate Charge ^{1,2}	Q_g	$V_{DS} = -10V, V_{GS} = -4.5V, I_D = -3.5A$		7.2		nC
Gate-Source Charge ^{1,2}	Q_{gs}			1.2		
Gate-Drain Charge ^{1,2}	Q_{gd}			2.3		
Turn-On Delay Time ^{1,2}	$t_{d(on)}$	$V_{DS} = -10V, I_D = -1A, V_{GS} = -4.5V, R_{GS} = 6\Omega$		17		nS
Rise Time ^{1,2}	t_r			32		
Turn-Off Delay Time ^{1,2}	$t_{d(off)}$			37		
Fall Time ^{1,2}	t_f			32		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_C = 25\text{ }^\circ\text{C}$)						
Continuous Current	I_S				-4.5	A
Pulsed Current ³	I_{SM}				-18	
Forward Voltage ¹	V_{SD}	$I_F = I_S, V_{GS} = 0V$			-1.2	V

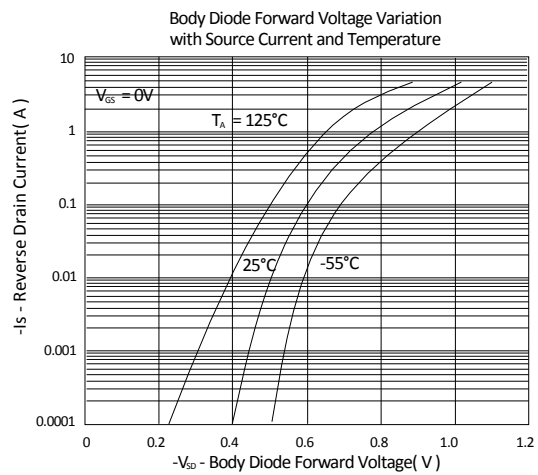
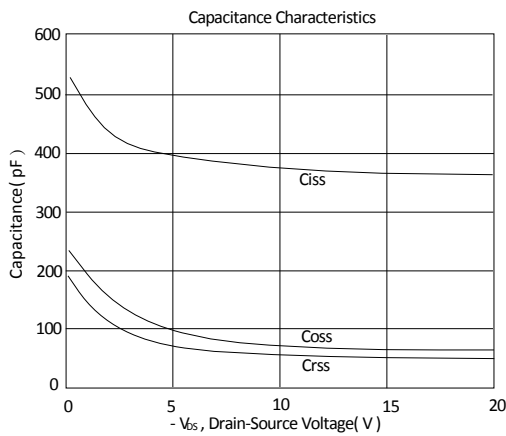
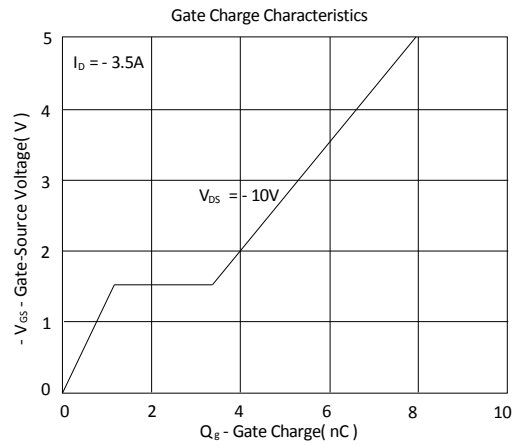
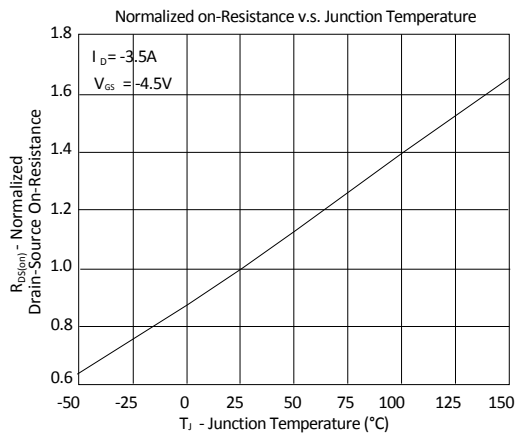
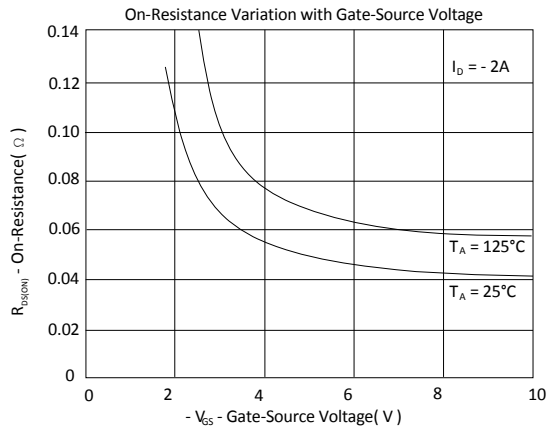
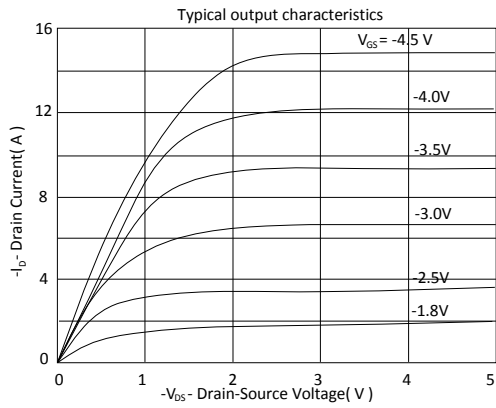
¹Pulse test : Pulse Width $\leq 300\text{ }\mu\text{sec}$, Duty Cycle $\leq 2\%$.

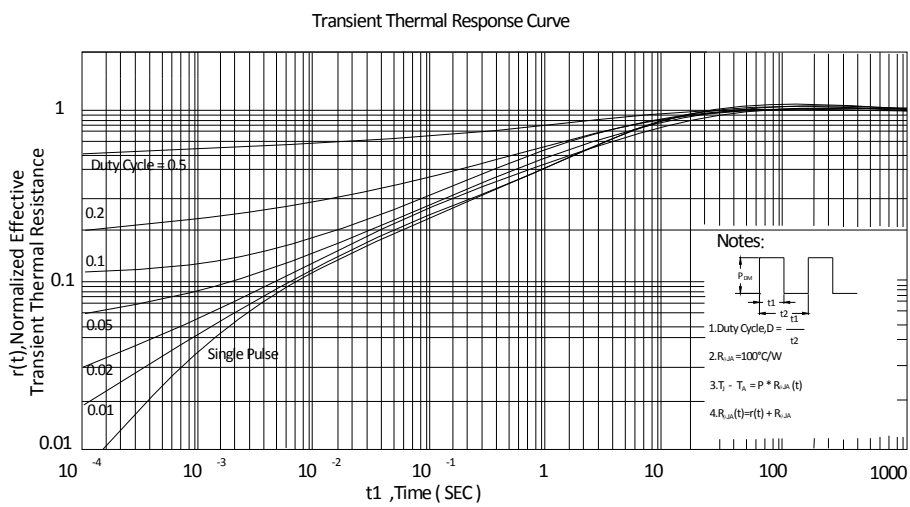
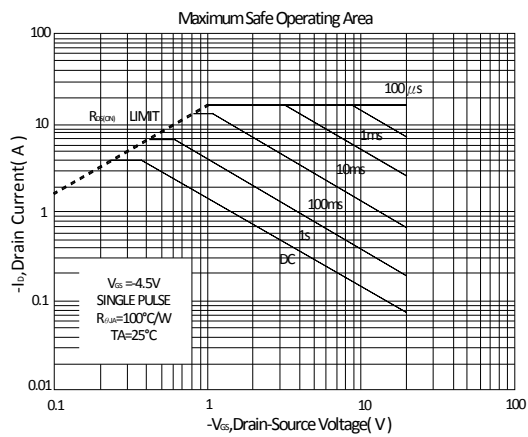
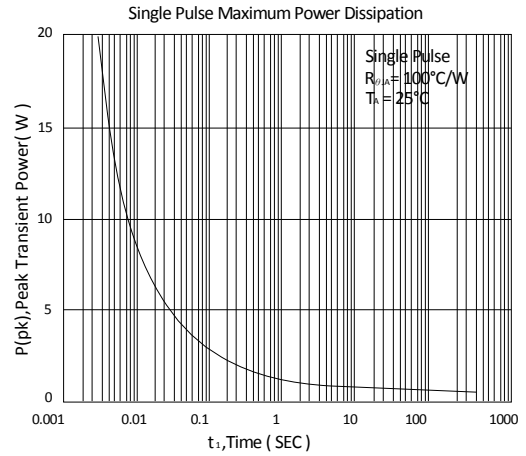
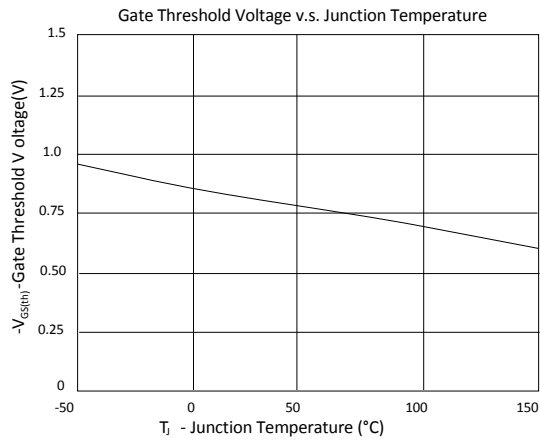
²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.



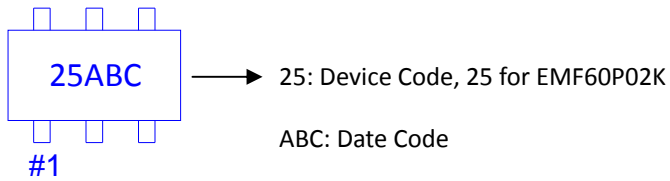
TYPICAL CHARACTERISTICS



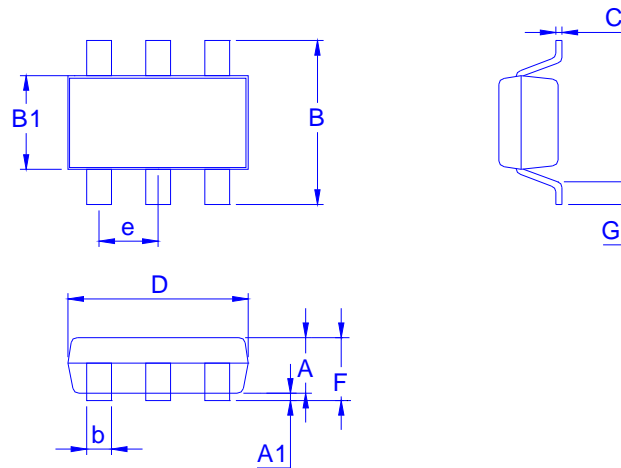


Ordering & Marking Information:

Device Name: EMF60P02K for TSOP-6



Outline Drawing



Dimension in mm

Dimension	A	A1	B	B1	b	C	D	e	F	G
Min.	0.70	0	2.50	1.50	0.30	0.08	2.70		0.75	0.30
Typ.			2.80	1.60	0.40		2.90	0.95		
Max.	1.00	0.10	3.10	1.70	0.50	0.20	3.10		1.10	0.60

Footprint

